AMENDMENT TRANSMITTAL EETTER (Large Entity) Docket No. OCT 0 4 2004 Applicant(s): Pogge et al FIS9-2002-0007US1 Filing Date Application No. Examiner Customer No. Group Art Unit Confirmation No. 10/605,204 09/15/03 Alonzo Chambliss 32074 2203 2827 INTEGRATED ELECTRONIC CHIP AND INTERCONNECT DEVICE AND PROCESS FOR MAKING Invention: THE SAME **COMMISSIONER FOR PATENTS:** Transmitted herewith is an amendment in the above-identified application. The fee has been calculated and is transmitted as shown below. CLAIMS AS AMENDED HIGHEST # **NUMBER EXTRA CLAIMS REMAINING ADDITIONAL** RATE AFTER AMENDMENT PREV. PAID FOR **CLAIMS PRESENT** FEE **TOTAL CLAIMS** 22 26  $0 \mid x$ \$18.00 \$0.00 3 3 0 x INDEP. CLAIMS = \$86.00 \$0.00 \$0.00 Multiple Dependent Claims (check if applicable) \$0.00 TOTAL ADDITIONAL FEE FOR THIS AMENDMENT X No additional fee is required for amendment. Please charge Deposit Account No. in the amount of A check in the amount of to cover the filing fee is enclosed.  $\mathbf{X}$ The Director is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 09-0458 Any additional filing fees required under 37 C.F.R. 1.16.  $\mathbf{X}$ Any patent application processing fees under 37 CFR 1.17. Dated: 10/01/04 Signature certify that this document and fee is being deposited on Jay H. Anderson 10/01/04 with the U.S. Postal Service as first Registration No: 38,371 class mail under 37 C.F.R. 1.8 and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA IBM Corporation, IPLAW

2070 Route 52, Bldg. 300, Zip 482 Hopewell Junction, New York 12533-6531 Telephone No. 845-894-3667

22313-1450

Teri McDonald

Typed or Printed Name of Person Mailing Correspondence



I HEREBY CERTIFY THAT THIS CORRESPONDENCE IS BEING DEPOSITED WITH THE UNITED STATES POSTAL SERVICE AS FIRST CLASS MAIL IN AN ENVELOPE ADDRESSED TO: THE COMMISSIONER FOR PATENTS, P.O. BOX 1450, ALEXANDRIA, VA 22313 ON: October 1, 2004.

Name of Person Making Deposit: TERI MCDONALD

Signature:

Date of Signature:

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

H. Bernhard Pogge et al.

Examiner: A. Chambliss

Application No.: 10/605,204

Group Art Unit: 2827

Filed: September 15, 2003

For:

INTEGRATED ELECTRONIC

CHIP AND INTERCONNECT DEVICE AND PROCESS FOR

MAKING THE SAME

Date: October 1, 2004

## AMENDMENT UNDER 37 C.F.R. § 1.111 AND SUBMISSION OF TERMINAL DISCLAIMER

The Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In reply to the Office Action dated July 1, 2004, please amend the above-identified application as follows: